





NE8FDH-M-Mb

etherCON Magnetics are horizontal PCB etherCON chassis connectors with integrated magnetics providing galvanic isolation and overvoltage protection.

These features save PCB space within the device design and provide improved frequency response when compared to standard designs.

Attention: this product is strictly not intended for use in PoE systems. Use in PoE systems may damage the connector.



Features & Benefits

- Integrated magnetics circuitry within the Space-saving design, as it removes the chassis connector need for HF part otherwise required on the customer motherboard. Components used: transformers, ferrite Saving costs on PCB (~20 parts) Support . core and Bob Smith termination for the voltage mode applications automatic termination in case of no cable connection Support voltage mode applications In case of overvoltage harm, the • connector can be exchanged, and the main board is still safe. Cat 5e (100Mbits and 1Gbits) Lowest crosstalk attenuation with the use • transmission performance according to of machined-designed transformer IEEE 802.3, 802.3b, and 802.3ab standards Overvoltage protection up to 2 kVGround-**Ground-panel connection** • panel connection
- Overvoltage protection >2 kV for 1Gb/s available via optional customer-installed capacitor

Note: not compatible with etherCON Cat 6 NE8MC6-MO



Technical Information

Product	
Title	NE8FDH-M-Mb
Gender	Female

Electrical

1 kVdc
> 0.5 G Ω
5
1.5 A
< 50 V
100 Mbps (Class D)
1-100 MHz
This product is strictly not intended for use in PoE systems.

Mechanical	
Insertion force	≤ 20 N
Withdraw force	≤ 20 N
Lifetime	> 1000 mating cycles
Panel thickness	Maximum 4 mm (0.16')
Wiring	Horizontal PCB mount
Locking device	Latch Lock
Chassis shape	D



Material	
Contact plating	Gold (Au)
Contacts	Bronze
Insert	РВТР
Shell	Zinc diecast
Shell plating	Nickel (Ni)

Environmental	
Temperature range	-30 °C to +80 °C
Maximum Operating Temperature	+80 °C
Flammability according to UL 94	V-0
Protection class according to IEC 60529	IP 40
Pollution degree according to IEC 60664-1	Pollution degree 2
Solderability	Complies with IEC 60068-2-20
Explosion environment	Not intended to be used within explosive environments